

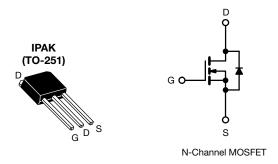
Vishay Siliconix

COMPLIANT

HALOGEN FREE

D Series Power MOSFET

PRODUCT SUMMARY					
V _{DS} (V) at T _J max.	550				
R _{DS(on)} max. (Ω) at 25 °C	V _{GS} = 10 V	3.2			
Q _g max. (nC)	12				
Q _{gs} (nC)	2				
Q _{gd} (nC)	3				
Configuration	Single				



FEATURES

- Optimal design
 - Low area specific on-resistance
 - Low input capacitance (Ciss)
 - Reduced capacitive switching losses
 - High body diode ruggedness
 - Avalanche energy rated (UIS)
- · Optimal efficiency and operation
 - Low cost
 - Simple gate drive circuitry
 - Low figure-of-merit (FOM): Ron x Qa
 - Fast switching
- Material categorization: for definitions of compliance please see <u>www.vishav.com/doc?99912</u>

APPLICATIONS

- Consumer electronics
 - -Displays (LCD or plasma TV)
- Server and telecom power supplies
 - SMPS
- Industrial
 - Welding
 - Induction heating
 - Motor drives
- · Battery chargers

ORDERING INFORMATION				
Package	IPAK (TO-251)			
Lead (Pb)-free	SiHU3N50D-E3			
Lead (Pb)-free and Halogen-free	SiHU3N50D-GE3			

ABSOLUTE MAXIMUM RATINGS (T _C = 25 °C, unless otherwise noted)						
PARAMETER			SYMBOL	LIMIT	UNIT	
Drain-Source Voltage			V _{DS}	500		
Gate-Source Voltage			.,	± 30	V	
Gate-Source Voltage AC (f > 1 Hz)			V_{GS}	30		
Continuous Drain Current (T _J = 150 °C)	V_{GS} at 10 V $\frac{T_C}{T_C} = \frac{T_C}{T_C}$	$T_{\rm C} = 25 ^{\circ}{\rm C}$ $T_{\rm C} = 100 ^{\circ}{\rm C}$		3.0		
		T _C = 100 °C	I _D	1.9	А	
Pulsed Drain Current ^a			I _{DM}	5.5		
Linear Derating Factor				0.56	W/°C	
Single Pulse Avalanche Energy b			E _{AS}	10.4	mJ	
Maximum Power Dissipation			P_{D}	69	W	
Operating Junction and Storage Temperature Range			T _J , T _{stg}	-55 to +150	°C	
Drain-Source Voltage Slope	T _J = 12	5 °C	dV/dt	24	V/ns	
Reverse Diode dV/dt d			uv/ut	0.22) v/ns	
Soldering Recommendations (Peak Temperature) c for 10 s			300	°C		

Notes

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. V_{DD} = 50 V, starting T_J = 25 °C, L = 2.3 mH, R_g = 25 Ω , I_{AS} = 3 Å.
- c. 1.6 mm from case.
- d. $I_{SD} \le I_D$, starting $T_J = 25$ °C.



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THERMAL RESISTANCE RATINGS					
PARAMETER	SYMBOL	TYP.	MAX.	UNIT	
Maximum Junction-to-Ambient	R _{thJA}	-	62	°C/W	
Maximum Junction-to-Case (Drain)	R_{thJC}	-	1.8	C/VV	

PARAMETER	SYMBOL	TEST CONDITIONS		MIN.	TYP.	MAX.	UNIT
Static						•	
Drain-Source Breakdown Voltage	V _{DS}	$V_{GS} = 0 \text{ V}, I_D = 250 \mu\text{A}$		500	-	-	V
V _{DS} Temperature Coefficient	$\Delta V_{DS}/T_{J}$	Reference	e to 25 °C, I _D = 250 μA	-	0.56	-	V/°C
Gate-Source Threshold Voltage (N)	V _{GS(th)}	V _{DS} =	· V _{GS} , I _D = 250 μA	3	-	5	V
Gate-Source Leakage	I _{GSS}	,	V _{GS} = ± 30 V		-	± 100	nA
Zava Cata Valtaga Dvain Coverent		V _{DS} =	V _{DS} = 500 V, V _{GS} = 0 V		-	1	
Zero Gate Voltage Drain Current	I _{DSS}	V _{DS} = 400 V	', V _{GS} = 0 V, T _J = 125 °C	-	-	10	μA
Drain-Source On-State Resistance	R _{DS(on)}	V _{GS} = 10 V	I _D = 2.5 A	-	2.6	3.2	Ω
Forward Transconductance a	9 _{fs}	V _{DS}	= 8 V, I _D = 1.5 A	-	1	-	S
Dynamic							
Input Capacitance	C _{iss}		$V_{GS} = 0 V$,	-	175	-	
Output Capacitance	C _{oss}	1	V _{DS} = 100 V,	-	21	-	
Reverse Transfer Capacitance	C _{rss}		f = 1 MHz	-	5	-	
Effective Output Capacitance, Energy Related ^b	C _{o(er)}	V 0VV 400V V 0V		-	21	-	pF -
Effective Output Capacitance, Time Related ^c	C _{o(tr)}	$V_{DS} = 0$	$V_{DS} = 0 \text{ V to } 400 \text{ V}, V_{GS} = 0 \text{ V}$		26	-	
Total Gate Charge	Qg			-	6	12	
Gate-Source Charge	Q _{gs}	$V_{GS} = 10 \text{ V}$ $I_D = 1.5 \text{ A}, V_{DS} = 400 \text{ V}$		-	2	-	nC
Gate-Drain Charge	Q _{gd}			-	3	-	
Turn-On Delay Time	t _{d(on)}	V _{DD} = 400 V, I _D = 1.5 A		-	12	24	ns
Rise Time	t _r			-	9	18	
Turn-Off Delay Time	t _{d(off)}	$R_g =$	$R_g = 9.1 \Omega, V_{GS} = 10 V$		11	22	
Fall Time	t _f				13	26	
Gate Input Resistance	R_g	f = 1 MHz, open drain		-	3.3	-	Ω
Drain-Source Body Diode Characteristic	s						
Continuous Source-Drain Diode Current	I _S	MOSFET symbol showing the integral reverse p - n junction diode		-	-	3	
Pulsed Diode Forward Current	I _{SM}			-	-	12	- A
Diode Forward Voltage	V _{SD}	T _J = 25 °C, I _S = 1.5 A, V _{GS} = 0 V		-	-	1.2	V
Reverse Recovery Time	t _{rr}	T _J = 25 °C, I _F = I _S = 1.5 A, dl/dt = 100 A/ μ s, V _R = 20 V		-	293	-	ns
Reverse Recovery Charge	Q _{rr}			-	0.74	-	μC
Reverse Recovery Current	I _{RRM}			_	5	-	A

- a. Repetitive rating; pulse width limited by maximum junction temperature.
- b. $C_{oss(er)}$ is a fixed capacitance that gives the same energy as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} . c. $C_{oss(tr)}$ is a fixed capacitance that gives the same charging time as C_{oss} while V_{DS} is rising from 0 % to 80 % V_{DSS} .



TYPICAL CHARACTERISTICS (25 °C, unless otherwise noted)

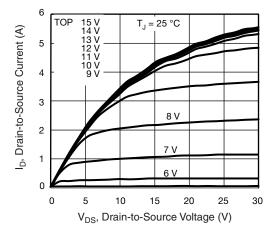


Fig. 1 - Typical Output Characteristics

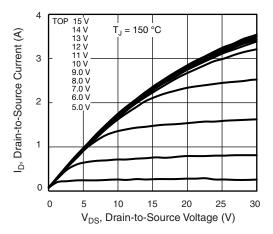


Fig. 2 - Typical Output Characteristics

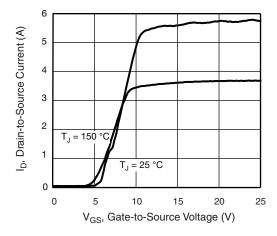


Fig. 3 - Typical Transfer Characteristics

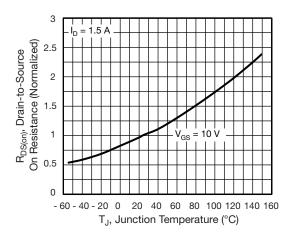


Fig. 4 - Normalized On-Resistance vs. Temperature

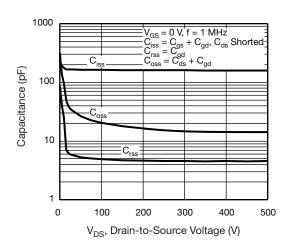


Fig. 5 - Typical Capacitance vs. Drain-to-Source Voltage

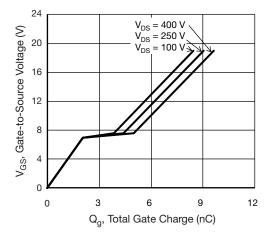


Fig. 6 - Typical Gate Charge vs. Gate-to-Source Voltage



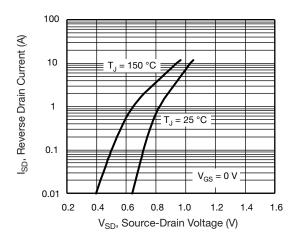


Fig. 7 - Typical Source-Drain Diode Forward Voltage

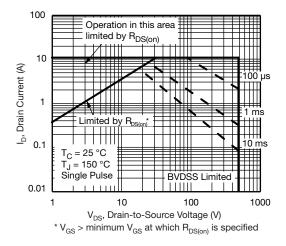


Fig. 8 - Maximum Safe Operating Area

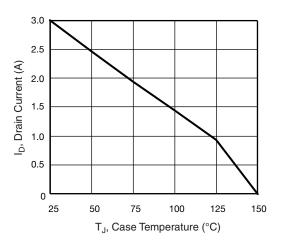


Fig. 9 - Maximum Drain Current vs. Case Temperature

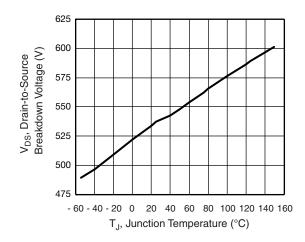


Fig. 10 - Typical Drain-to-Source Voltage vs. Temperature

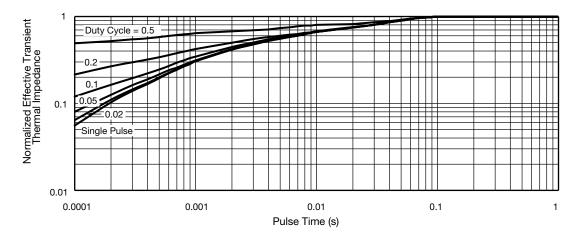


Fig. 11 - Normalized Thermal Transient Impedance, Junction-to-Case



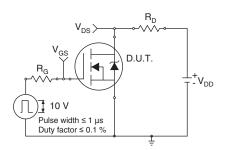


Fig. 12 - Switching Time Test Circuit

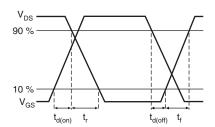


Fig. 13 - Switching Time Waveforms

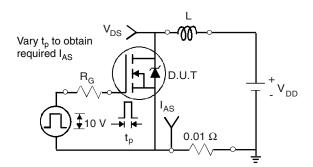


Fig. 14 - Unclamped Inductive Test Circuit

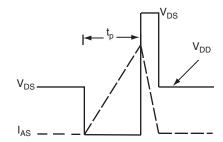


Fig. 15 - Unclamped Inductive Waveforms

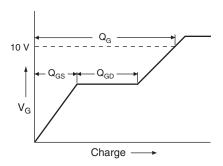


Fig. 16 - Basic Gate Charge Waveform

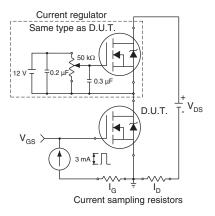
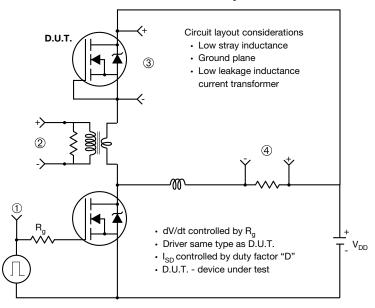


Fig. 17 - Gate Charge Test Circuit



Peak Diode Recovery dV/dt Test Circuit



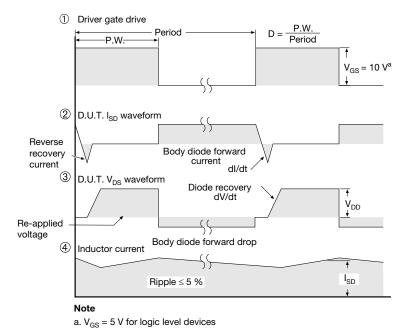
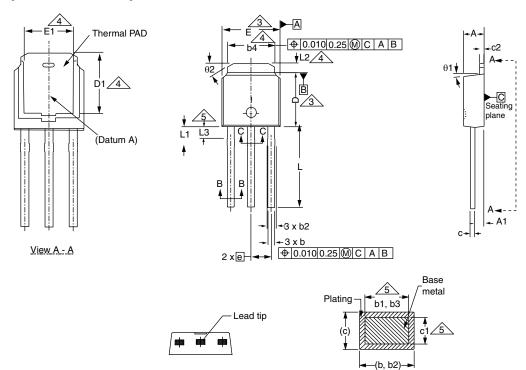


Fig. 18 - For N-Channel

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TO-251AA (HIGH VOLTAGE)



MILLIMETERS INCHES DIM. MIN. MAX. MIN. MAX. Α 2.18 2.39 0.086 0.094 Α1 0.89 1.14 0.035 0.045 b 0.64 0.89 0.025 0.035 b1 0.65 0.79 0.026 0.031 0.76 1.14 0.030 0.045 b2 b3 0.76 1.04 0.030 0.041 b4 4.95 5.46 0.195 0.215 0.61 0.018 0.024 0.46 С с1 0.41 0.56 0.016 0.022 c2 0.46 0.86 0.018 0.034 5.97 6.22 0.235 0.245

	MILLIN	IETERS	INC	HES	
DIM.	MIN.	MAX.	MIN.	MAX.	
D1	5.21	-	0.205	-	
Е	6.35	6.73	0.250	0.265	
E1	4.32	-	0.170	-	
е	2.29	BSC	2.29 BSC		
L	8.89	9.65	0.350	0.380	
L1	1.91	2.29	0.075	0.090	
L2	0.89	1.27	0.035	0.050	
L3	1.14	1.52	0.045	0.060	
θ1	0'	15'	0'	15'	
θ2	25'	35'	25'	35'	

Section B - B and C - C

ECN: S-82111-Rev. A, 15-Sep-08

DWG: 5968

- 1. Dimensioning and tolerancing per ASME Y14.5M-1994.
- 2. Dimension are shown in inches and millimeters.
- 3. Dimension D and E do not include mold flash. Mold flash shall not exceed 0.13 mm (0.005") per side. These dimensions are measured at the outermost extremes of the plastic body.
- 4. Thermal pad contour optional with dimensions b4, L2, E1 and D1.
- 5. Lead dimension uncontrolled in L3.
- 6. Dimension b1, b3 and c1 apply to base metal only.
- 7. Outline conforms to JEDEC outline TO-251AA.

Document Number: 91362 Revision: 15-Sep-08



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